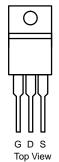


## 90N4F3-VB TO220 Datasheet N-Channel 40-V (D-S) MOSFET

PRODUCT SUMMARY		
V <sub>DS</sub>	40	V
$R_{DS(on)} V_{GS} = 10 V$	6	mΩ
I <sub>D</sub>	110	А
Configuration	Sin	gle

## TO-220AB

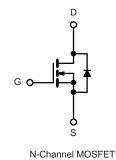


### FEATURES

- TrenchFET<sup>®</sup> Power MOSFET
- 100 %  $\rm R_g$  and UIS Tested

#### APPLICATIONS

- Synchronous Rectification
- Power Supplies



ABSOLUTE MAXIMUM RATING	$\mathbf{S} \mathbf{T}_{A} = 25 \mathbf{C},  unless$	ss otherwise note	u	r
Parameter		Symbol	Limit	Unit
Drain-Source Voltage Gate-Source Voltage		V <sub>DS</sub>	40	v
		V <sub>GS</sub>	± 20	v
	T <sub>C</sub> = 25 °C		110 <sup>a, c</sup>	
Continuous Drain Current (T <sub>J</sub> = 175 °C)	T <sub>C</sub> = 70 °C		90 <sup>c</sup>	
	T <sub>A</sub> = 25 °C	I <sub>D</sub>	31 <sup>b</sup>	Α
	T <sub>A</sub> = 70 °C		25 <sup>b</sup>	
Pulsed Drain Current		I <sub>DM</sub>	270	
Avalanche Current Pulse	L = 0.1 mH	I <sub>AS</sub>	85	
Single Pulse Avalanche Energy	L = 0.1 mm	E <sub>AS</sub>	320	V
Continuous Source Droin Diada Current	T <sub>C</sub> = 25 °C		110 <sup>a, c</sup>	Α
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	2.6 <sup>b</sup>	
	T <sub>C</sub> = 25 °C		312 <sup>a</sup>	
Maximum Power Dissipation	T <sub>C</sub> = 70 °C	P <sub>D</sub>	200	w
	T <sub>A</sub> = 25 °C	F D	3.13 <sup>b</sup>	vv
	T <sub>A</sub> = 70 °C		2.0 <sup>b</sup>	
Operating Junction and Storage Temperature Ra	ange	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient <sup>b</sup>	Steady State	R <sub>thJA</sub>	32	40	°C/W
Maximum Junction-to-Case	Steady State	R <sub>thJC</sub>	0.33	0.4	0/2

Notes:

a. Based on T<sub>C</sub> = 25 °C.

b. Surface Mounted on 1" x 1" FR4 board.

c. Calculated based on maximum junction temperature. Package limitation current is 110 A.

<b>SPECIFICATIONS</b> $T_J = 25 \ ^{\circ}C$ ,	unless other	wise noted					
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static			•		•	•	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_D = 250 \mu A$	40			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = 250 μA		41		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	$I_D = 250 \mu A$		- 8		mv/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1.2		2.5	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zara Cata Valtaga Drain Current		$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$			1	μA	
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 \text{ °C}$			10	μΑ	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	120			Α	
Drain-Source On-State Resistance <sup>a</sup>	Provide	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 30 \text{ A}$	6				
	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, I_D = 20 \text{ A}$		7		mΩ	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 30 \text{ A}$		180		S	
Dynamic <sup>b</sup>							
Input Capacitance	C <sub>iss</sub>			2900		pF	
Output Capacitance	C <sub>oss</sub>	$V_{DS}$ = 20 V, $V_{GS}$ = 0 V, f = 1 MHz		750			
Reverse Transfer Capacitance	C <sub>rss</sub>			310			
Total Gate Charge	Qg			130			
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 20$ V, $V_{GS} = 10$ V, $I_{D} = 20$ A		20		nC	
Gate-Drain Charge	Q <sub>gd</sub>			32			
Gate Resistance	R <sub>g</sub>	f = 1 MHz		0.85	1.3	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			20	30		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 20 V, $R_L$ = 1.0 $\Omega$		11	17		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong$ 20 A, $V_{GEN}$ = 10 V, $R_g$ = 1 $\Omega$		77	115	1	
Fall Time	t <sub>f</sub>			10	15		
Turn-On Delay Time	t <sub>d(on)</sub>			102	155	ns	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 20 V, $R_L$ = 1.0 $\Omega$		62	95	-	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong$ 20 A, $V_{GEN}$ = 4.5 V, $R_g$ = 1 $\Omega$		180	270		
Fall Time	t <sub>f</sub>			60	90		
Drain-Source Body Diode Characteristic	S						
Continuous Source-Drain Diode Current	۱ <sub>S</sub>	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$			110	А	
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				200		
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 20 A		0.8	1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			50	75	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>F</sub> = 20 A, di/dt = 100 A/μs, T <sub>J</sub> = 25 °C		70	105	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	$r_{\rm F} = 20$ Å, and $= 100$ Å/µs, $r_{\rm J} = 20$ C		30		200	
Reverse Recovery Rise Time	t <sub>b</sub>			20		ns	

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

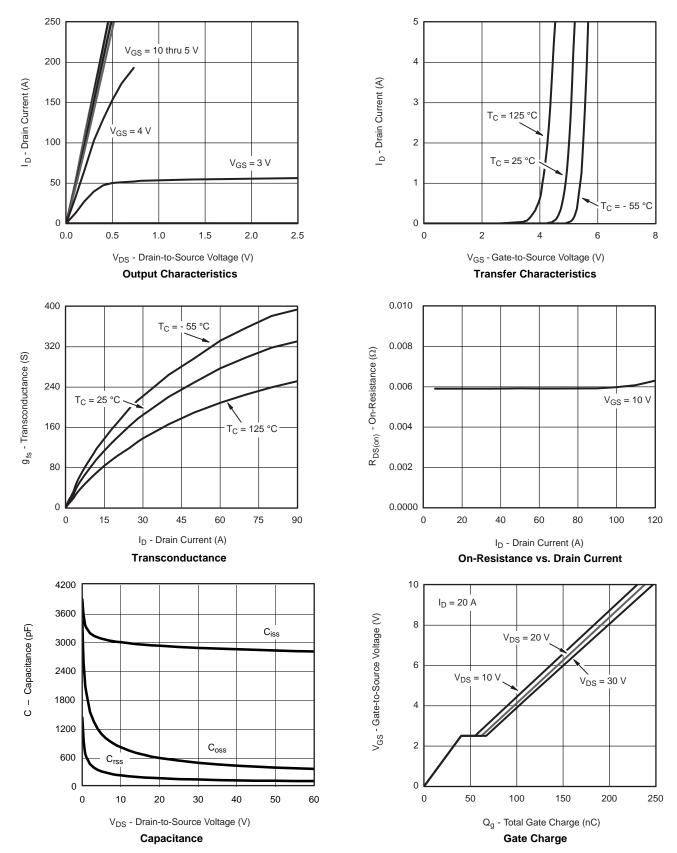
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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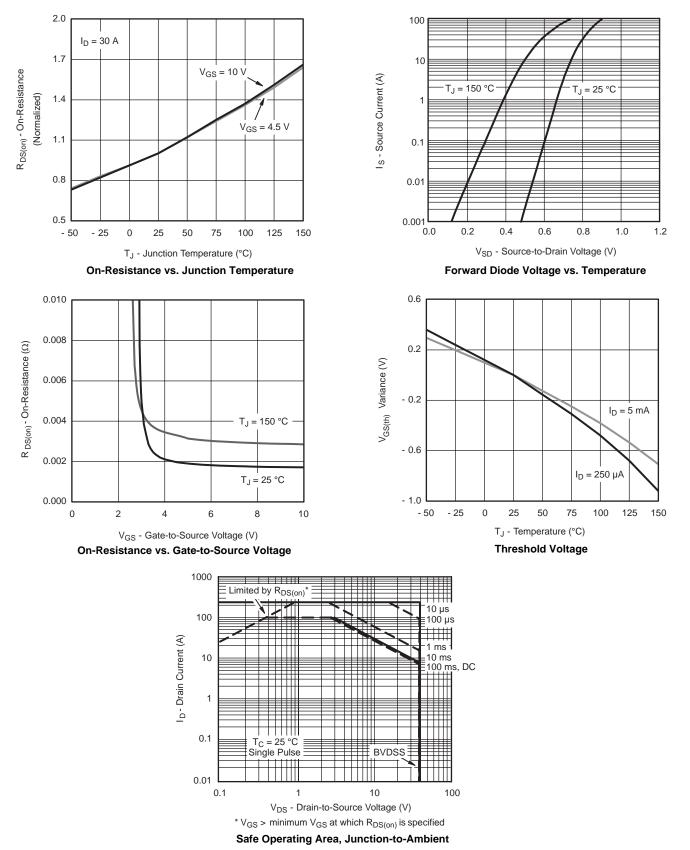
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

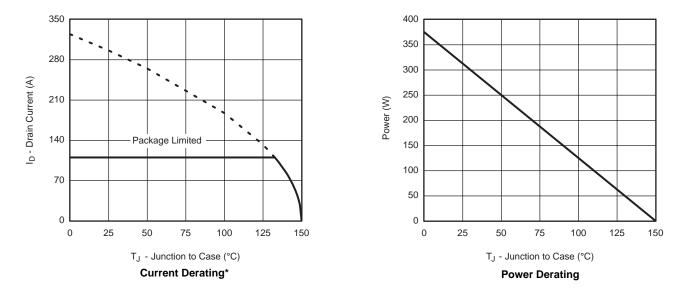


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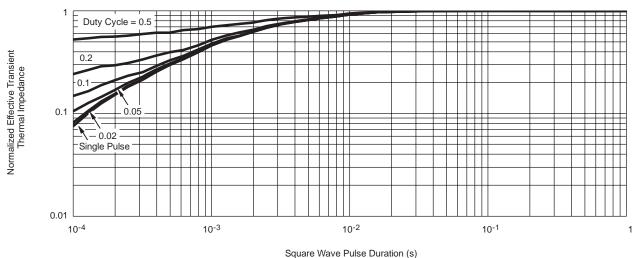
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\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

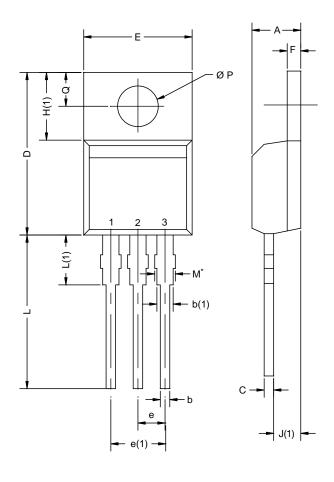


Normalized Thermal Transient Impedance, Junction-to-Case

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## **TO-220AB**



	MILLIN	IETERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.25	4.65	0.167	0.183	
b	0.69	1.01	0.027	0.040	
b(1)	1.20	1.73	0.047	0.068	
С	0.36	0.61	0.014	0.024	
D	14.85	15.49	0.585	0.610	
Е	10.04	10.51	0.395	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.09	6.48	0.240	0.255	
J(1)	2.41	2.92	0.095	0.115	
L	13.35	14.02	0.526	0.552	
L(1)	3.32	3.82	0.131	0.150	
ØР	3.54	3.94	0.139	0.155	
Q	2.60	3.00	0.102	0.118	

#### Notes

\* M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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